

MP34DT01

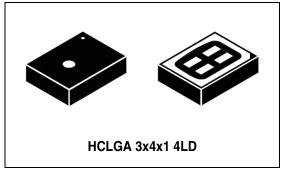
MEMS audio sensor omnidirectional digital microphone

Features

- Single supply voltage
- Low power consumption
- 120 dBSPL acoustic overload point
- 63 dB signal-to-noise ratio
- Omnidirectional sensitivity
- -26 dBFS sensitivity
- PDM output
- HCLGA package
 - Top-port design
 - SMD-compliant
 - EMI-shielded
 - ECOPACK®, RoHS, and "Green" compliant

Applications

- Mobile terminals
- Laptop and notebook computers
- Portable media players
- VolE
- Speech recognition
- A/V eLearning devices
- Gaming and virtual reality input devices
- Digital still and video cameras
- Antitheft systems



Description

The MP34DT01 is an ultra-compact, low-power, omnidirectional, digital MEMS microphone built with a capacitive sensing element and an IC interface.

The sensing element, capable of detecting acoustic waves, is manufactured using a specialized silicon micromachining process dedicated to produce audio sensors.

The IC interface is manufactured using a CMOS process that allows designing a dedicated circuit able to provide a digital signal externally in PDM format.

The MP34DT01 has an acoustic overload point of 120 dBSPL with a 63 dB signal-to-noise ratio and –26 dBFS sensitivity.

The MP34DT01 is available in a top-port, SMD-compliant, EMI-shielded package and is guaranteed to operate over an extended temperature range from -30 °C to +70 °C.

Table 1. Device summary

| Part number | Temperature range [°C] | Package | Packing |
|-------------|------------------------|--------------------------|---------------|
| MP34DT01 | -30 to +70 | HCLGA (3 x 4 x 1) mm 4LD | Tray |
| MP34DT01TR | -30 to +70 | HCLGA (3 x 4 x 1) mm 4LD | Tape and reel |

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MP34DT01 Pin description

1 Pin description

Figure 1. Pin connections

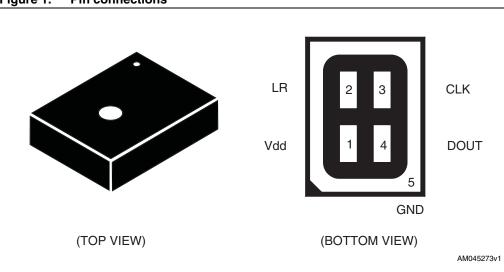


Table 2. Pin description

| Pin # | Pin name | Function | |
|-----------------|----------|------------------------------|--|
| 1 | Vdd | Power supply | |
| 2 | LR | Left/Right channel selection | |
| 3 | CLK | Synchronization input clock | |
| 4 | DOUT | Left/Right PDM data output | |
| 5 (ground ring) | GND | 0 V supply | |

2 Acoustic and electrical specifications

2.1 Acoustic and electrical characteristics

The values listed in the table below are specified for Vdd = 1.8 V, Clock = 2.4 MHz, T = 25 $^{\circ}$ C, unless otherwise noted.

Table 3. Acoustic and electrical characteristics

| Symbol | Parameter | Test condition | Min. | Typ. ⁽¹⁾ | Max. | Unit |
|--------|-------------------------------------------------------|------------------------------|------|---------------------|------|-------|
| Vdd | Supply voltage | | 1.64 | 1.8 | 2.86 | V |
| Idd | Current consumption in normal mode | Mean value | | 0.6 | | mA |
| IddPdn | Current consumption in power-down mode ⁽²⁾ | | | 20 | | μΑ |
| Scc | Short-circuit current | | 1 | | 10 | mA |
| AOP | Acoustic overload point | | | 120 | | dBSPL |
| So | Sensitivity | | -29 | -26 | -23 | dBFS |
| SNR | Signal-to-noise ratio | A-weighted at 1 kHz, 1 Pa | | 63 | | dB |
| PSR | Power supply rejection | Guaranteed by design | | -70 | | dBFS |
| Clock | Input clock frequency(3) | | 1 | 2.4 | 3.25 | MHz |
| Ton | Turn-on time (4) | Guaranteed by design | | | 10 | ms |
| Тор | Operating temperature range | | -30 | | +70 | °C |

^{1.} Typical specifications are not guaranteed.

Table 4. Distortion specifications

| Parameter | Test condition | Value |
|------------|---------------------------|--------------|
| Distortion | 100 dBSPL (50 Hz - 4 kHz) | <1 % THD + N |
| Distortion | 115 dBSPL (1 kHz) | <5 % THD + N |

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^{2.} Input clock in static mode.

^{3.} Duty cycle: min = 40% max = 60%.

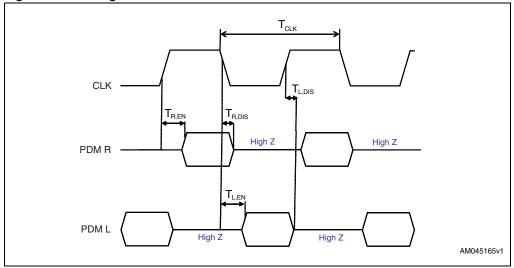
^{4.} Time from the first clock edge to valid output data.

2.2 Timing characteristics

Table 5. Timing characteristics

| Parameter | Description | Min | Max | Unit |
|--------------------|-----------------------------------------|-----|------|------|
| f _{CLK} | Clock frequency for normal mode | 1 | 3.25 | MHz |
| f _{PD} | Clock frequency for power-down mode | | 0.23 | MHz |
| T _{CLK} | Clock period for normal mode | 308 | 1000 | ns |
| T _{R,EN} | Data enabled on DATA line, L/R pin = 1 | 16 | | ns |
| $T_{R,DIS}$ | Data disabled on DATA line, L/R pin = 1 | | 16 | ns |
| T _{L,EN} | Data enabled on DATA line, L/R pin = 0 | 18 | | ns |
| T _{L,DIS} | Data disabled on DATA line, L/R pin = 0 | | 16 | ns |

Figure 2. Timing waveforms



2.3 Frequency response

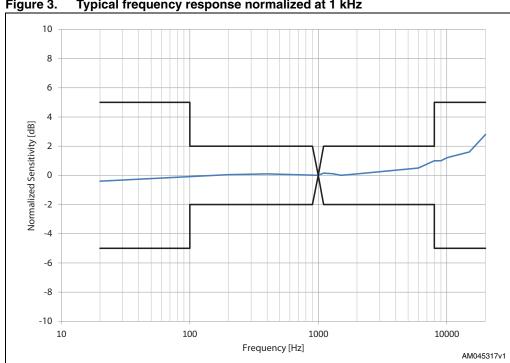


Figure 3. Typical frequency response normalized at 1 kHz

Table 6. Frequency response mask for digital microphones

| Frequency / Hz (1) | Lower limit | Upper limit | Unit |
|--------------------|-------------|-------------|----------|
| 20100 | -5 | +5 | dBr 1kHz |
| 1008000 | -2 | +2 | dBr 1kHz |
| 800020000 | -5 | +5 | dBr 1kHz |

^{1.} At T = 20 °C and acoustic stimulus = 1 Pa (94 dB SPL)

3 Absolute maximum ratings

Stresses above those listed as "absolute maximum ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device under these conditions is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

Table 7. Absolute maximum ratings

| Symbol | Ratings | Maximum value | Unit |
|------------------|------------------------------------|------------------|------|
| Vdd | Supply voltage | -0.3 to 6 | V |
| Vin | Input voltage on any control pin | -0.3 to Vdd +0.3 | V |
| T _{STG} | Storage temperature range | -40 to +125 | °C |
| ESD | Electrostatic discharge protection | 2 (HBM) | kV |



This device is sensitive to mechanical shock, improper handling can cause permanent damage to the part.



This device is ESD-sensitive, improper handling can cause permanent damage to the part.

Functionality MP34DT01

4 Functionality

4.1 L/R channel selection

The L/R digital pad lets the user select the DOUT signal pattern as shown in *Table 8*. The L/R pin must be connected to Vdd or GND.

Table 8. L/R channel selection

| L/R | CLK low | CLK high |
|-----|----------------|----------------|
| GND | Data valid | High impedance |
| Vdd | High impedance | Data valid |

5 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Soldering information

The HCLGA 3x4 4LD package is also compliant with the RoHS and "Green" standards and is qualified for soldering heat resistance according to JEDEC J-STD-020.

Landing pattern and soldering recommendations are available at www.st.com.

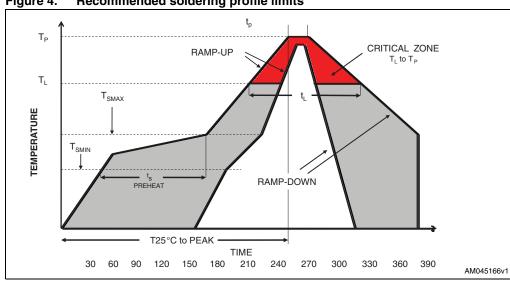


Figure 4. Recommended soldering profile limits

Recommended soldering profile limits Table 9.

| Description | Parameter | Pb free |
|------------------------------------------------|----------------------------------|-------------------|
| Average ramp rate | T _L to T _P | 3 °C/sec max |
| Preheat | | |
| Minimum temperature | T _{SMIN} | 150 °C |
| Maximum temperature | T _{SMAX} | 200 °C |
| Time (T _{SMIN} to T _{SMAX}) | t _S | 60 sec to 120 sec |
| Ramp-up rate | T_{SMAX} to T_{L} | |
| Time maintained above liquidous temperature | tL | 60 sec to 150 sec |
| Liquidous temperature | T_L | 217 °C |
| Peak temperature | T _P | 260 °C max |
| Time within 5 °C of actual peak temperature | | 20 sec to 40 sec |
| Ramp-down rate | | 6 °C/sec max |
| Time 25 °C (t25 °C) to peak temperature | | 8 minutes max |

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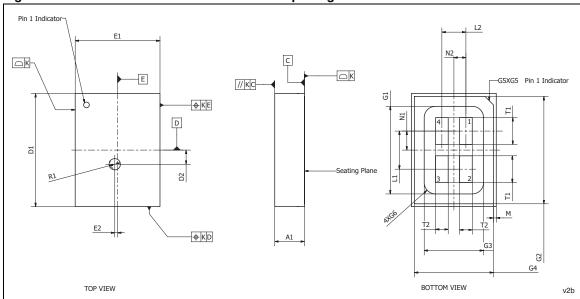


Figure 5. HCLGA 3 mm x 4 mm x 1 mm 4-lead package outline

Table 10. HCLGA 3 mm x 4 mm x 1 mm 4-lead package dimensions

| mm | | |
|-------|-------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Min | Тур | Max |
| 0.900 | 1.000 | 1.100 |
| 3.900 | 4.000 | 4.100 |
| 0.300 | 0.500 | 0.700 |
| 0.300 | 0.400 | 0.500 |
| 2.900 | 3.000 | 3.100 |
| 1.300 | 1.500 | 1.700 |
| 1.300 | 1.350 | 1.400 |
| 0.800 | 0.850 | 0.900 |
| 0.625 | 0.675 | 0.725 |
| 0.375 | 0.425 | 0.475 |
| 0.900 | 0.950 | 1.000 |
| 0.350 | 0.400 | 0.450 |
| 3.050 | 3.100 | 3.150 |
| 3.750 | 3.800 | 3.850 |
| 2.050 | 2.100 | 2.150 |
| 2.750 | 2.800 | 2.850 |
| 0.250 | 0.300 | 0.350 |
| | 0.400 | |
| | 0.100 | |
| | 0.050 | |
| | 0.900 3.900 0.300 0.300 2.900 1.300 1.300 0.800 0.625 0.375 0.900 0.350 3.050 3.750 2.050 2.750 | Min Typ 0.900 1.000 3.900 4.000 0.300 0.500 0.300 0.400 2.900 3.000 1.300 1.500 1.300 1.350 0.800 0.850 0.625 0.675 0.375 0.425 0.900 0.950 0.350 3.100 3.750 3.800 2.050 2.100 2.750 2.800 0.250 0.300 0.400 0.100 |

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MP34DT01 Revision history

6 Revision history

Table 11. Document revision history

| Date | Revision | Changes | |
|-------------|----------|------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| 06-Oct-2011 | 1 | Initial release | |
| 18-Nov-2011 | 2 | Removed "stereo" from title, Features, and Description | |
| 29-Nov-2011 | 3 | Updated Features and Description | |
| 04-Jan-2012 | 4 | Updated Figure 3: Typical frequency response normalized at 1 kHz Added So limits to Table 3: Acoustic and electrical characteristics Minor textual updates | |

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